

### **About this document**

### **Scope and purpose**

This application note describes Infineon's BGA5M1BN6 as a Low Noise Amplifier (LNA) for Global Navigation Satellite System (GNSS) applications in the frequency range of 1559 MHz to 1610 MHz.

The BGA5M1BN6 is a silicon germanium (SiGe) LNA.

- 1. The target applications of this circuit are GPS L1/Galileo E1/GLONASS L1/BeiDou B1/QZSS L1 modules in the range of 1559 MHz to 1610 MHz.
- 2. In this report, the performance of BGA5M1BN6 is investigated on a FR4 board. This device is matched with 0402 size high Q-factor LQW15 inductors. Noise Figure (NF) deviation, when matched with 0201 size LQP03T inductors, is also presented.
- 3. Key performance parameters at 1.8 V, 1575 MHz:

High Gain Mode

NF = 0.85 dB (LQW15 inductors for matching)

NF = 1.0 dB (LQP03T inductors for matching)

Insertion gain = 17.5 dB

Input return loss = 11 dB

Output return loss = 13 dB

Out-of-band input IM3 = -48 dBm (measured at 1575 MHz)

Bypass Mode Insertion loss = 17.5 dB Input return loss = 11 dB Output return loss = 13 dB



### Introduction of the Global Navigation Satellite System

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1) The graphs were generated with the simulation program AWR Microwave Office®.



#### **Introduction of the Global Navigation Satellite System** 1

#### **Global Navigation Satellite System (GNSS)** 1.1

The Global Navigation Satellite System (GNSS) covers the mostly commonly used services in the electronic industry. Today, the following GNSS systems are in operation: the United States GPS, the Russian GLobal Orbiting Navigation Satellite System (GLONASS), the Chinese BeiDou Navigation Satellite System (BDS), the European Union Galieo navigation system (Galileo), the Japanese Quasi-Zenith Satellite System (QZSS) and the Indian Regional Navigation Satellite System (IRNSS or NavIC). Main market segments include GNSSenabled cell phones, Personal Navigation Devices (PNDs), GNSS-enabled portable devices and Internet-of-Things (IoT) devices.

For the GNSS-enabled cell phones, the main challenges are to achieve high sensitivity and high immunity for safety and emergency reasons against interference from cellular signals and other wireless connectivity signals. The GNSS signals must be received at very low power levels (down to less than -130 dBm) in cell phones in the vicinity of coexisting high-power cellular and other wireless connectivity signals.

The main challenges for the GNSS-enabled portable devices are to obtain a high system sensitivity for precise detection, and low Time-To-First Fix (TTFF) to quickly locate the device. Below diagram demonstrates the RF frontend structure of a GNSS-enabled portable module. The LNA is switched to high gain mode when the module does not use the external active antenna, and to bypass mode when the module switches to external active antenna.

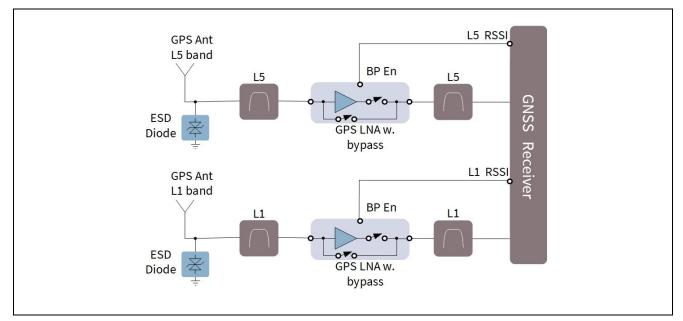


Figure 1 Application diagram: receiver front end of the GNSS

#### 1.2 **Lower L bands**

The GNSS systems were first operated in the upper L band ranging from 1559 MHz to 1610 MHz. Recently, GNSS applications in the lower L bands, ranging from 1164 MHz to 1300 MHz, have started to emerge in civil use.





The lower L bands include GPS L5/GLONASS L3/BDS B2/Galileo E5/QZSS L5/NavIC L5 bands (1164 MHz to 1217 MHz), and GPS L2/GLONASS L2/BDS B3/Galileo E6/QZSS L2C/QZSS LEX bands (1217 MHz to 1300 MHz).

For example, the GPS L5 band hosts a civilian safety-of-life signal, and is intended to provide a means of radio navigation secure and robust enough for life-critical applications, such as aircraft precision approach guidance. The GPS L2 band has been used for high-precision location navigation.

Figure 2 illustrates an overview of the frequency allocation of GNSS applications.

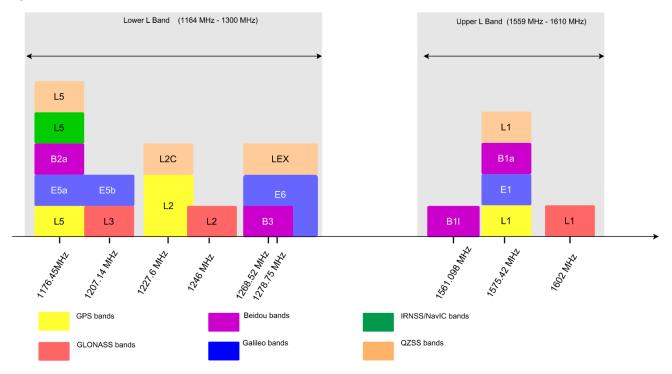


Figure 2 Frequency allocation of GNSS systems, upper L band and lower L band

#### 1.3 Infineon product portfolio for GNSS applications

Infineon Technologies offers the following product portfolio to all customers designing high-performance flexible RF front-end solutions for all GNSS systems:

- LNAs: Infineon offers a wide range of products such as high-performance Monolithic Microwave Integrated Circuits (MMICs) as well as cost-effective and high-end RF transistors
- Transient Voltage Suppression (TVS) diodes: Infineon devices can protect GNSS antennas reliably up to 20 kV

#### 1.4 **Key features of GNSS LNAs**

Infineon is among the leading suppliers of GNSS LNAs for navigation applications. The GNSS MMIC LNAs are designed with the following features:

#### 1.4.1 Low NF and high gain

The power levels of satellite signals received by a GNSS receiver are as low as -130 dBm. An external LNA with exceptionally low NF and good gain helps to boost the signal-to-noise ratio of the system. The existing LNA portfolio includes devices with various gain levels to be tailored to customers' RF systems.

## BGA5M1BN6 as a Bypass LNA for GNSS applications from 1559 MHz in fine on **Introduction of the Global Navigation Satellite System**



#### 1.4.2 High robustness against coexistence of out-of-band jammer signals

In the presence of very weak GNSS satellite signals, there is no inband interference signal in the GNSS receiver front ends.

In the case of cell phone systems, GNSS signals coexist with strong jammer signals from other RF applications, e.g. 3G/4G, wireless LAN, etc. The above out-of-band jammer signals can mix to produce intermodulation products in the GNSS receiver frequency band. Compared with the received signal level from GNSS satellites, the resulting intermodulation products are significant interference, so LNAs with high robustness against out-of-band interference signals are required.

#### 1.4.3 Low current consumption

Power consumption is an important feature in many GNSS systems that are mainly battery-operated mobile devices. Infineon's LNAs have an integrated power-on/-off feature that provides for low power consumption and increased stand-by time for GNSS handsets. Moreover, the recent development has focused on low current (e.g. 1.1 mA) and low supply voltage (1.2 V), making the LNAs suitable for portable devices such as GNSS-enabled wearables and connected IoT devices.

Please visit www.infineon.com for more details on LNA products for navigation in cell phones and portable devices.



#### 2 **BGA5M1BN6** overview

#### 2.1 **Features**

• Operating frequencies: 1805 MHz to 2200 MHz

• Insertion power gain: 19.3 dB

• Insertion loss in bypass mode: 4.7 dB

• Low NF: 0.65 dB

• Low current consumption: 9.5 mA

• Multi-state control: bypass and high-gain mode

• Ultra-small TSNP-6-10 leadless package

• RF output internally matched to 50  $\Omega$ 

• Low external component count



Figure 3 **BGA5M1BN6 in TSNP-6-10** 





#### 2.2 **Key applications of BGA5M1BN6**

BGA5M1BN6 is designed to enhance receiving sensitivity in LTE applications.

In this application note, it is retuned to improve the reception quality of the GNSS applications.

In high-gain mode the LNA offers the best NF to ensure high sensitivity. In bypass mode, the LNA works under reduced current consumption. The integrated bypass function increases the overall system dynamic range and leads to more flexibility in the RF front end.

Please visit the <u>product page</u> of BGA5M1BN6 for more information.



Application circuit and performance overview

### 3 **Application circuit and performance overview**

In this chapter the performance of the application circuit, the schematic and Bill of Materials (BOM) are presented.

**Device:** BGA5M1BN6

**Application:** LNA for GNSS applications in the range 1559 MHz to 1610 MHz

**PCB** marking: BGAxxxN6 V4.0

**EVB** order no.: AN612

#### 3.1 **Summary of measurement results**

The performance of BGA5M1BN6 for GNSS higher L band applications is summarized in the following tables.

Table 1 Electrical characteristics at 1.8 V (at room temperature)

Parameter	Symbol	Va	lue	Unit	Comment/test condition
Frequency range	Freq	1575		MHz	B1/E1/L1 center frequencies
DC voltage	V <sub>cc</sub>	1	8	V	
Mode	М	High gain	Bypass		
DC current	I <sub>cc</sub>	9.3	0.09	mA	High Gain Mode, Bypass Mode
Gain	G	17.5	-4.4	dB	
Noise Figure <sup>1)</sup>	NF	0.85	4.7	dB	LQW15 inductor for matching, loss of input line of 0.10 dB is de- embedded <sup>1)</sup>
Noise Figure <sup>2)</sup>	NF	1.0	4.9	dB	LQP03TN inductor for matching, loss of input line of 0.10 dB is de- embedded <sup>2)</sup>
Input return loss	$RL_in$	11	12	dB	
Output return loss	$RL_out$	13	6	dB	
Reverse isolation	I <sub>Rev</sub>	41	4	dB	
Input IP3	IIP3	-9	-2	dBm	Power at input: -30 dBm f1 = 1575 MHz, f2 = 1576 MHz
Input P1dB	IP1dB	-20	-4	dBm	At 1575 MHz
Out-of-band input IP3 <sup>3)</sup>	Oob_IIP3	-48	-72	dBm	Power at input: -20 dBm
Out-of-band output IM3	Oob_OIM3	-30	-76	dBm	f1 =1712 MHz f2= 1850 MHz Oob_IM3 measured at 1575 MHz
Out-of-band input IP2 <sup>3)</sup>	Oob_IIP2	-1	18	dBm	Power at input: -28 dBm
Out-of-band output IM2	Oob_OIM2	-37	-78	dBm	f1 = 827 MHz, f2 = 2402 MHz Oob_IM2 measured at 1575 MHz
Out-of-band input IP2 <sup>3)</sup>	Oob_IIP2	19	36	dBm	Power at input: -20 dBm



**Application circuit and performance overview** 

Table 1 Electrical characteristics at 1.8 V (at room temperature)

Parameter	Symbol	Value		Unit	Comment/test condition
Out-of-band output IM2	Oob_OIM2	-41	-80	dBm	f1 = 1950 MHz, f2 = 3525 MHz
	_				Oob_IM2 measured at 1575 MHz
Stability	К	>1		-	Measured up to 10 GHz

<sup>3)</sup> Out-of-band input IMx = IM level output referred – gain at the measured frequency

Table 2 Electrical characteristics at 2.8 V (at room temperature)

Table 2 Licetificate characteristics at 2.5 v (at 100m temperature)						
Parameter	Symbol	Va	lue	Unit	Comment/test condition	
Frequency range	Freq	1575		MHz	B1/E1/L1 center frequencies	
DC voltage	V <sub>cc</sub>	2.8		٧		
DC current	I <sub>cc</sub>	9.97	0.09	mA		
Gain	G	17.5	-4.4	dB		
Noise Figure <sup>1)</sup>	NF	0.90	4.7	dB	LQW15 inductor for matching, loss of input line of 0.10 dB is de- embedded <sup>1)</sup>	
Noise Figure <sup>2)</sup>	NF	1.0	4.9	dB	LQP03TN inductor for matching, loss of input line of 0.10 dB is de- embedded <sup>2)</sup>	
Input return loss	$RL_in$	11	12	dB		
Output return loss	$RL_out$	12	6	dB		
Reverse isolation	I <sub>Rev</sub>	41	4	dB		
Input IP3	IIP3	-9	-2	dBm	Power at input: -30 dBm f1 = 1575 MHz, f2 = 1576 MHz	
Input P1dB	IP1dB	-19	-4	dBm	At 1575 MHz	
Out-of-band input IP3 <sup>3)</sup>	Oob_IIP3	-6	6	dBm	Power at input: -20 dBm	
Out-of-band output IM3	Oob_OIM3	-30	-76	dBm	f1 = 1712 MHz, f2 = 1850 MHz Oob_IM3 measured at 1575 MHz	
Out-of-band input IP23)	Oob_IIP2	-1	18	dBm	Power at input: -28 dBm	
Out-of-band output IM2	Oob_OIM2	-37	-78	dBm	f1 = 827 MHz, f2 = 2402 MHz Oob_IM2 measured at 1575 MHz	
Out-of-band input IP2 <sup>3)</sup>	Oob_IIP2	19	36	dBm	Power at input: -20 dBm f1 = 1950 MHz, f2 = 3525 MHz	
Out-of-band output IM2	Oob_OIM2	-41	-80	dBm	Oob_IM2 measured at 1575 MHz	
Stability	К	>1		_	Measured up to 10 GHz	

<sup>3)</sup> Out-of-band input IMx = IM level output referred – gain at the measured frequency



Application circuit and performance overview

### 3.2 Schematic and BOM

The schematic of BGA5M1BN6 for GNSS applications is presented in **Figure 4** and its BOM is shown in **Table 3**.

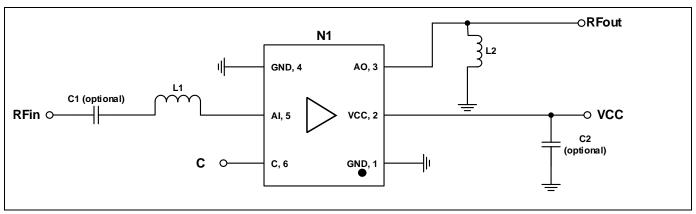


Figure 4 Schematic of the BGA5M1BN6 application circuit

Table 3 BOM

Symbol	Value	Unit	Size	Manufacturer	Comment
C1	1	nF	0402/0201	Various	DC block (optional)
C2	1	nF	0402/0201	Various	RF bypass (optional)
L1	6.8	nH	0402/0201	Murata LQW15/LQP03T	Input matching
L2	6.2	nH	0402/0201	Murata LQW15/LQP03T	Output matching
N1	BGA5M1BN6	TSNP-6-2		Infineon Technologies	SiGe LNA

Note: DC block function is NOT integrated at the input pin. DC block capacitor C1 is not necessary if the DC block function on the RF input line can be ensured by the previous stage. For reducing switching time, lower DC block cap value is recommended. C1 = 100 pF enables less than 3 µS switching time.

Note: The RF bypass capacitor C2 at the DC power supply pin filters out the power supply noise and stabilizes the DC supply. The C2 is not necessary if a clean and stable DC supply can be ensured.



**Measurement graphs** 

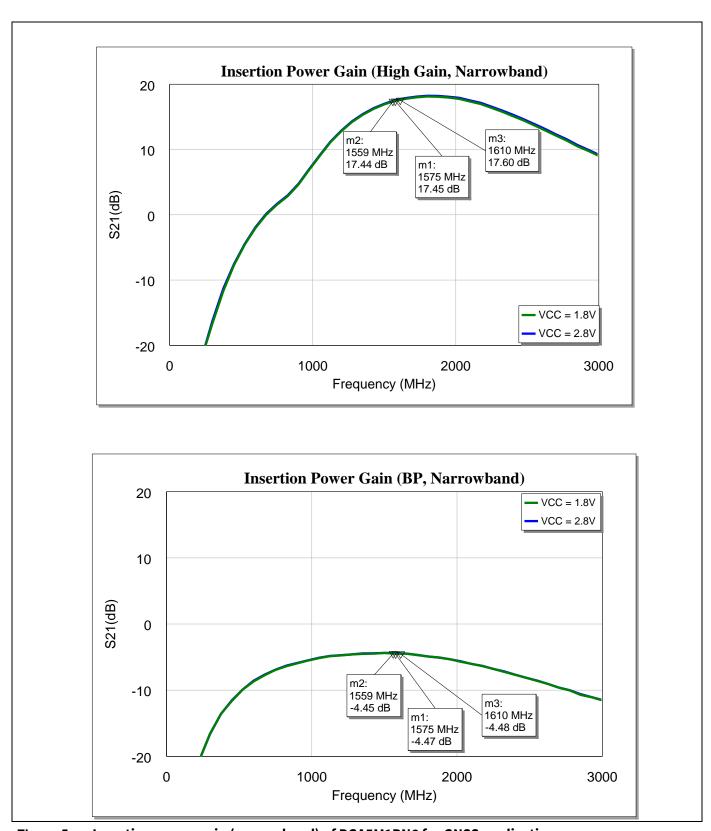


Figure 5 Insertion power gain (narrowband) of BGA5M1BN6 for GNSS applications



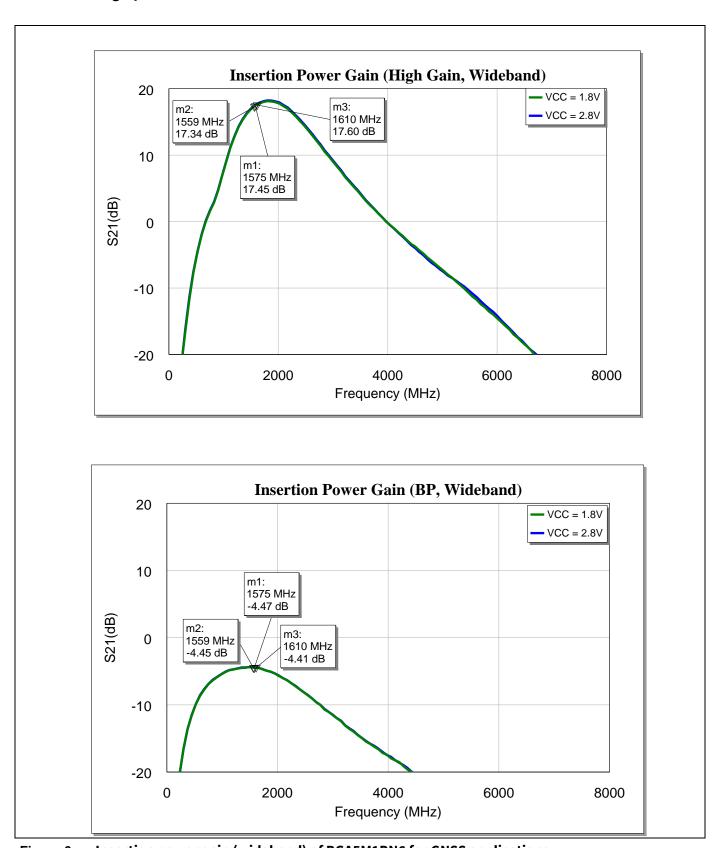


Figure 6 Insertion power gain (wideband) of BGA5M1BN6 for GNSS applications



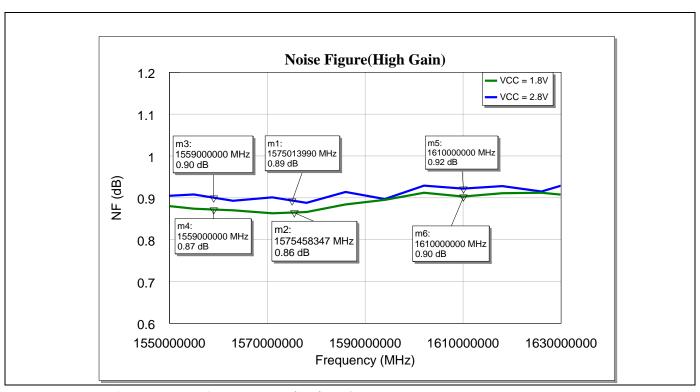


Figure 7 NF of BGA5M1BN6 for GNSS applications (SMA and connector losses de-embedded, LQW15 inductors for matching)

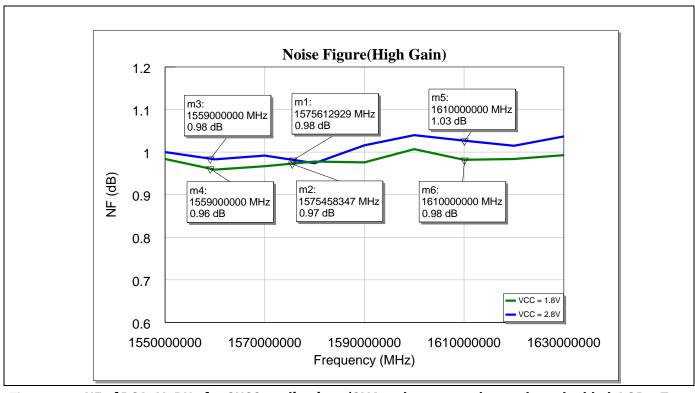
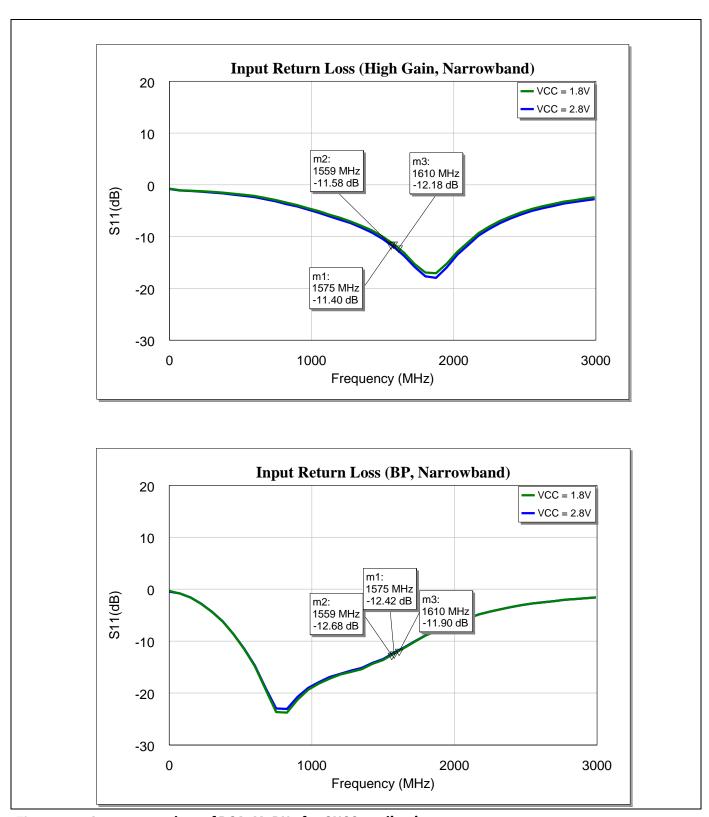


Figure 8 NF of BGA5M1BN6 for GNSS applications (SMA and connector losses de-embedded, LQP03T inductors for matching)





Input return loss of BGA5M1BN6 for GNSS applications Figure 9



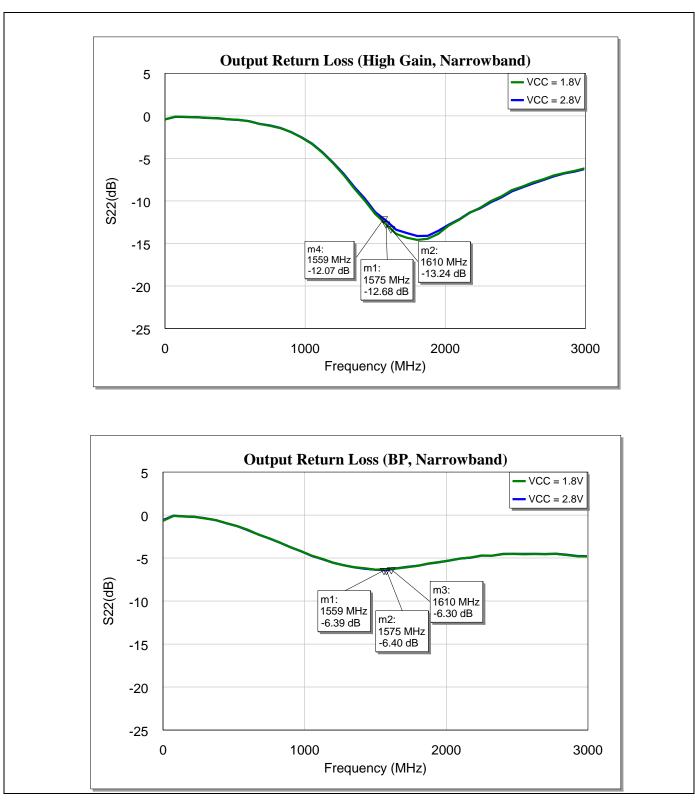


Figure 10 Output return loss of BGA5M1BN6 for GNSS applications



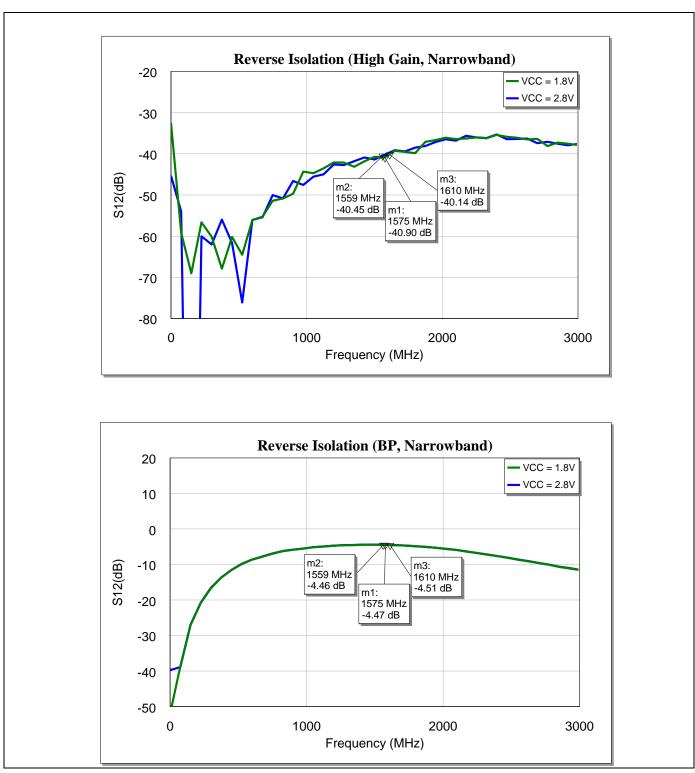


Figure 11 Reverse isolation of BGA5M1BN6 for GNSS applications



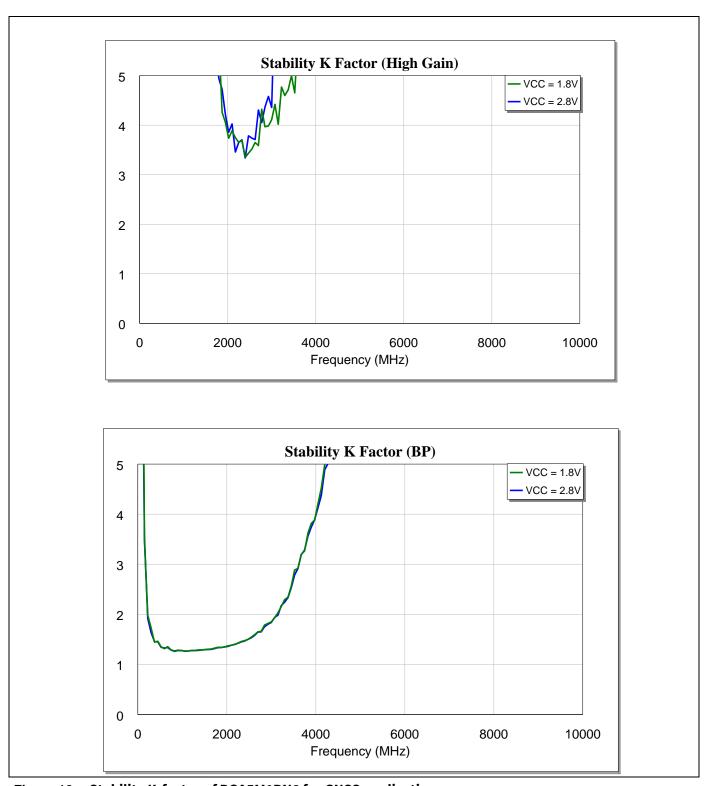


Figure 12 Stability K-factor of BGA5M1BN6 for GNSS applications

Figure 13 Stability Mu1-factor, Mu2-factor of BGA5M1BN6 for GNSS applications



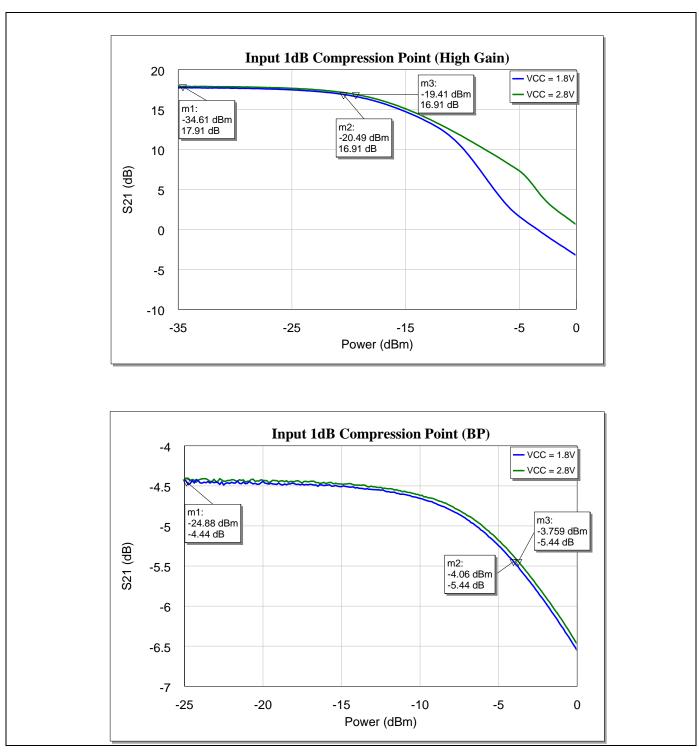


Figure 14 Input 1 dB compression point of BGA5M1BN6 for GNSS applications



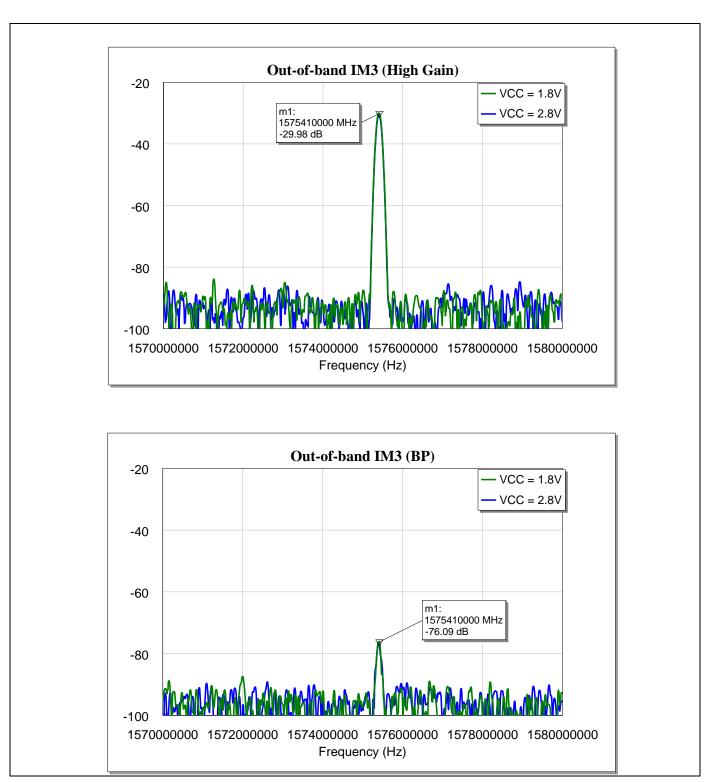


Figure 15 Out-of-band third-order intermodulation point of BGA5M1BN6 for GNSS applications (L1 band, power at input: -20 dBm, f1 = 1712 MHz, f2 = 1850 MHz, output referred)



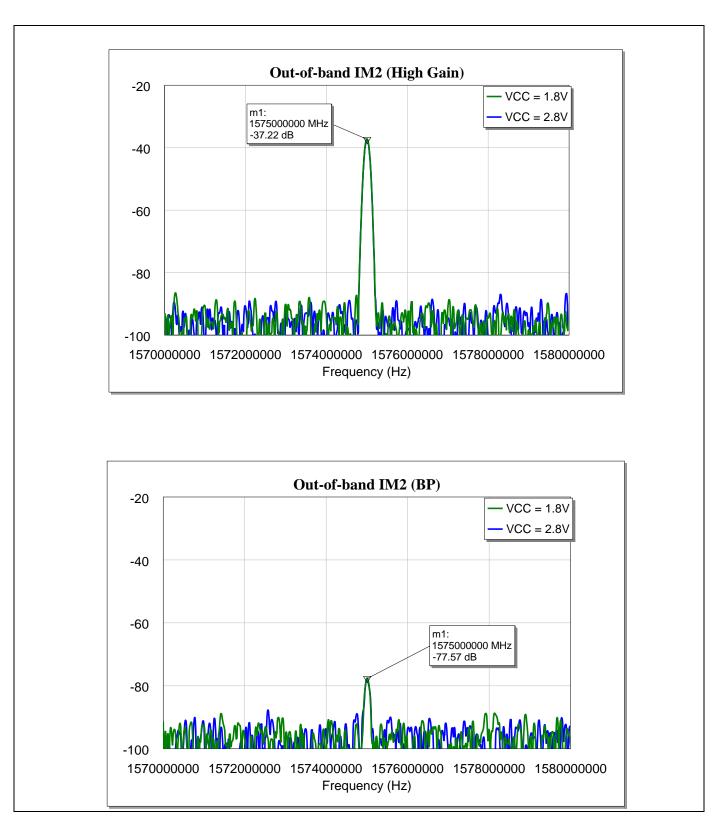


Figure 16 Out-of-band second-order intermodulation point of BGA5M1BN6 for GNSS applications (L1 band, power at input: -28 dBm, f1 = 827 MHz, f2 = 2402 MHz, output referred)



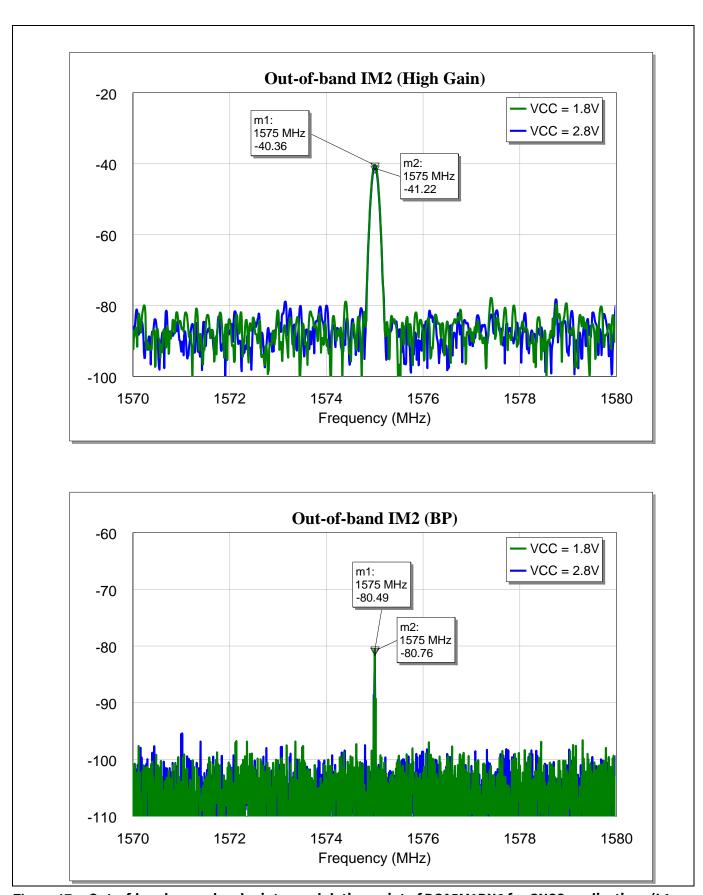
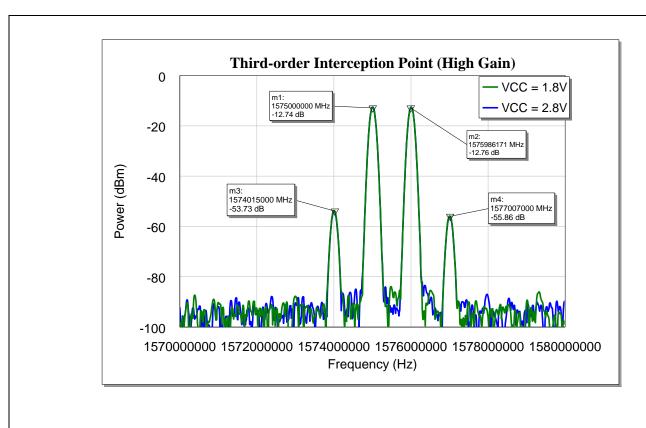


Figure 17 Out-of-band second-order intermodulation point of BGA5M1BN6 for GNSS applications (L1 band, power at input: -20 dBm, f1 = 1950 MHz, f2 = 3525 MHz, output referred)





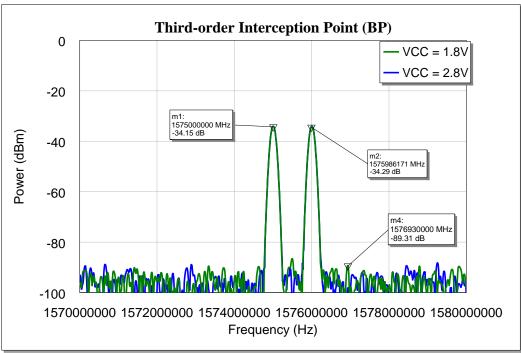


Figure 18 Inband third-order intermodulation point of BGA5M1BN6 for GNSS applications (1.8 V, 1575 MHz, output referred)



**Evaluation board and layout information** 

### **Evaluation board and layout information** 5

In this application note, the following PCB is used:

PCB marking: BGA5xxxN6 V4.0

PCB material: FR4

 $\varepsilon_r$  of PCB material: 4.8

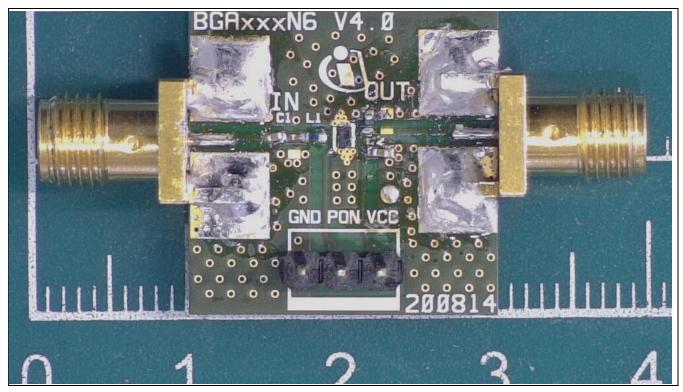


Figure 19 Evaluation board (overview)

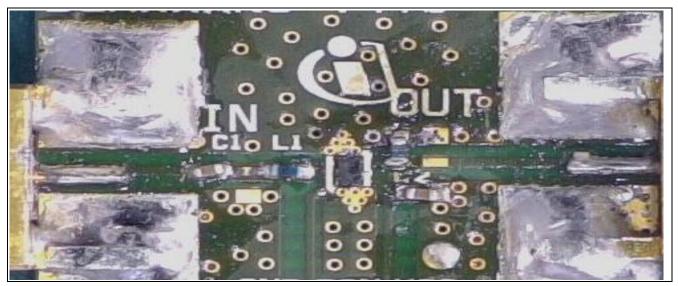


Figure 20 Evaluation board (detailed view)



### **Evaluation board and layout information**

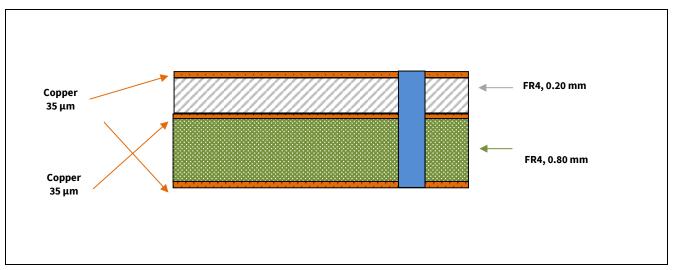


Figure 21 PCB layer information



**Authors** 

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**References** 

#### 7 References

- [1] <a href="https://en.wikipedia.org/wiki/GPS signals">https://en.wikipedia.org/wiki/GPS signals</a>
- [2] https://galileognss.eu/galileo-frequency-bands/
- http://www.navipedia.net/index.php/GNSS\_signal
- [4] <a href="https://www.gps.gov/systems/gps/modernization/civilsignals/">https://www.gps.gov/systems/gps/modernization/civilsignals/</a>

## **Revision history**

Major changes since the last revision Rev 1.0

Page or reference	Description of change

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Email: erratum@infineon.com

**Document reference** AN\_2004\_PL55\_2005\_140502

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